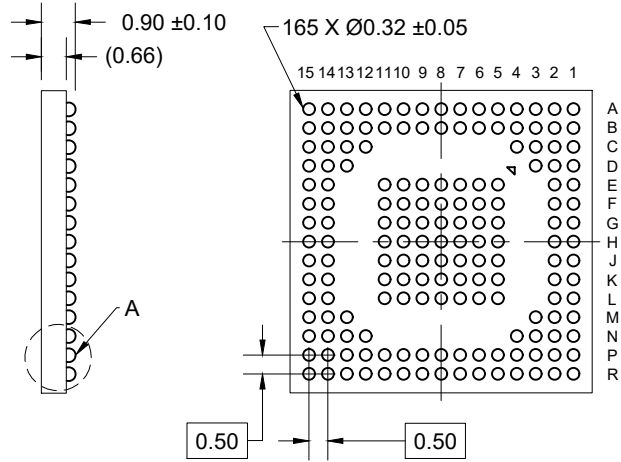
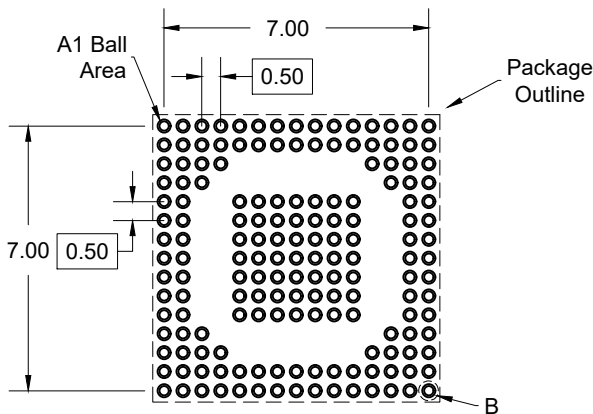


TOP VIEW

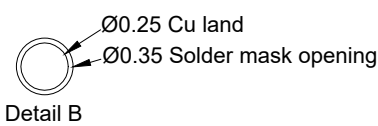
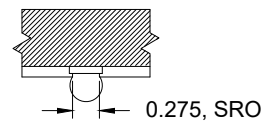
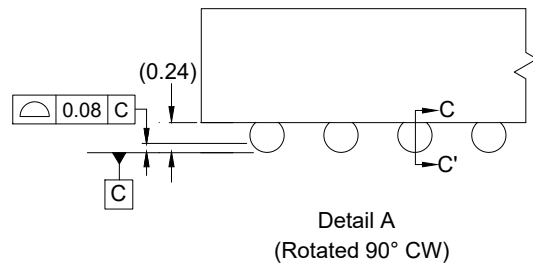


SIDE VIEW

BOTTOM VIEW



RECOMMENDED LAND PATTERN
(PCB Top View, NSMD Design)



NOTES:

1. JEDEC compatible.
2. All dimensions are in mm and angles are in degrees.
3. Use ± 0.05 mm for the non-toleranced dimensions.
4. Numbers in () are for references only.
5. Pre-reflow solderball diameter is $\text{Ø}0.3$ mm.